

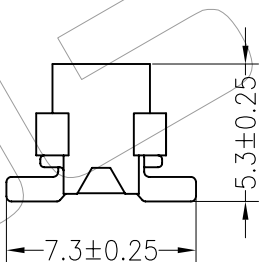
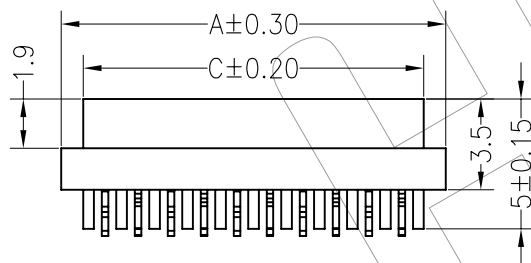
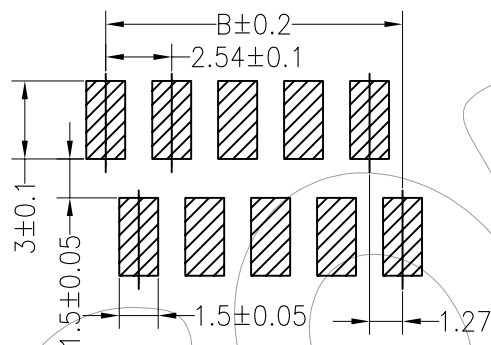
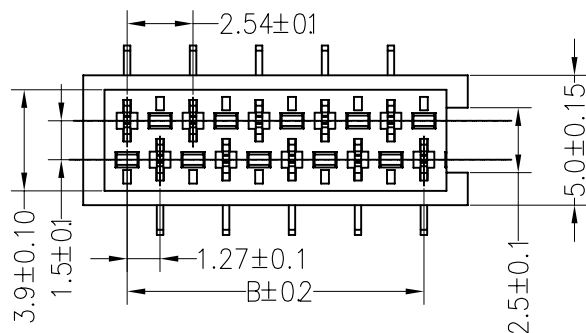
RoHS

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE ± 0.05)

SPECIFICATIONS

Rated Current:1.0AMP
Contact Resistance:20m Ω Max
Withstand Voltage:500V AC/DC
Insulation Resistance:1000M Ω Min
Operation Temperature:-40 $^{\circ}$ c to +105 $^{\circ}$ c

Contact Material:Phosphor Bronze
Contact Plating:Sn Over Ni
Insulator Material:Polyester(UL94V-0)
Standard: PA46
Max.Processing Temp: 230 $^{\circ}$ C for 30-60 seconds
(260 $^{\circ}$ C for 10 seconds)



PINS	A	B	C
4	7.00	3.81	5.60
6	9.54	6.35	8.14
8	12.08	8.89	10.68
10	14.62	11.43	13.22
12	17.16	13.97	15.76
14	19.70	16.51	18.30
16	22.24	19.05	20.84
18	24.78	21.59	23.38
20	27.32	24.13	25.92
22	29.86	26.67	28.46
24	32.40	29.21	31.00
26	34.94	31.75	33.54

Ordering Information
HC-MH XX F M SN X N X 01

No.of
Pins
04~26P

Contact Plating
S0:Gold Flash/Tin
SN:Sn

Insulator Material
Option
A=BK-PBT
D=BK-PA46

Packing
T=Tube
R=Reel

HECON 东莞市禾康电子有限公司
DONGGUAN HECON ELECTRONICS CO.,LTD

PART NO. HC-MHXXFMSNXX01

TITLE: Micro Match Female SMT Type

OPERATION

X.X ± 0.30

X.XX ± 0.20

X.XXX ± 0.10

Angle $\pm 3^{\circ}$

DIM TOL

DRAW

Ayang

CHECK

APPROVE

SCALE

FIT

UNIT

mm

SIZE

A4

SHEET

1/1

PROJ.

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